

### **AMENDMENT TO THE SPECIFICATION**

*Please amend the Abstract of the Disclosure as follows:*

A distributor (1) for distributing a flow of cooling fluid over one or more surface(s) (3) to be cooled has a housing (13) that may be manufactured in a single piece together with inlet (8) and outlet (9) manifolds and a plurality of flow cells (26, 27, 28, 29). -The flow cells (26, 27, 28, 29) may be connected in parallel between the manifolds (8, 9), and may be adapted to cool multiple surfaces (3) simultaneously. ~~The present invention is also directed to a~~ A fluid-coolable unit comprising including such a distributor (1) for removing may be utilized to remove heat from an electronic circuit, such as integrated circuit or CPU.